2SC5950G

Silicon NPN epitaxial planar type

For general amplification Complementary to 2SA2122G

Features

- \bullet High forward current transfer ratio h_{FE}
- Smini typ package, allowing downsizing of the equipment and automatic insertion through the tape packing

Absolute Maximum Ratings $T_a = 25^{\circ}C$ Rating Parameter Symbol Unit V Collector-base voltage (Emitter open) V_{CBO} 60 Collector-emitter voltage (Base open) V V_{CEO} 50 7 V Emitter-base voltage (Collector open) V_{EBO} Collector current 100 $I_{\rm C}$ mА 200 Peak collector current mA I_{CP} Collector power dissipation $P_{\rm C}$ 150 mW Ti 150 °C Junction temperature Storage temperature T_{stg} -55 to +150 °C

- Package
- Code
- SMini3-F2
- Marking Symbol: 7M
- Pin Name
- 1: Base
- 2: Emitter
- 3: Collector

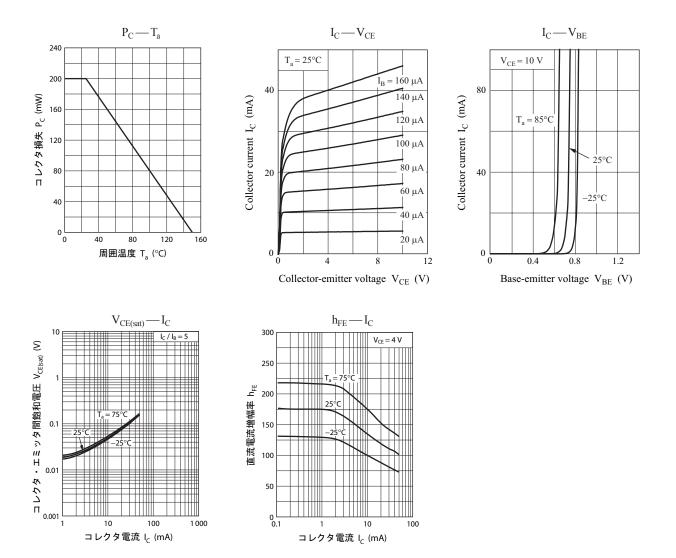
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{\rm C} = 10 \ \mu {\rm A}, \ I_{\rm E} = 0$	60			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = 2 {\rm mA}, I_{\rm B} = 0$	50			V
Emitter-base voltage (Collector open)	V_{EBO}	$I_{\rm E} = 10 \ \mu A, I_{\rm C} = 0$	7			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 20 \text{ V}, I_E = 0$			0.1	μΑ
Collector-emitter cutoff current (Base open)	I _{CEO}	$V_{CE} = 10 \text{ V}, I_B = 0$			100	μΑ
Forward current transfer ratio	\mathbf{h}_{FE}	$V_{CE} = 10 \text{ V}, I_C = 2 \text{ mA}$	160		460	
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 100 \text{ mA}, I_{\rm B} = 10 \text{ mA}$		0.1	0.3	V
Transition frequency	f_{T}	$V_{CB} = 10 \text{ V}, I_E = -2 \text{ mA}, f = 200 \text{ MHz}$		100		MHz
Collector output capacitance (Common base, input open circuited)	C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		2.2		pF

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

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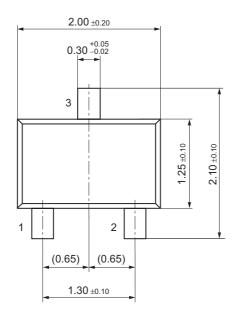
Panasonic

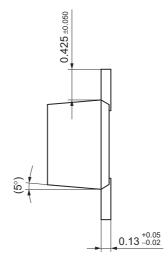


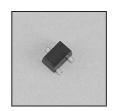
Panasonic

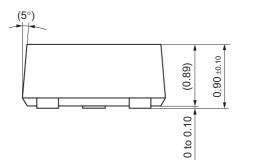
SMini3-F2

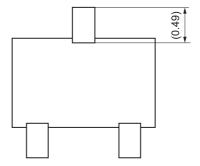
Unit: mm











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